

Request for Class II Permissive Change

FCC ID: IBAMF8235

Date: 12th July 2017

To: Federal Communication Commission

Please be notified that we, the undersigned, Creative Labs Inc declare the following changes to enhance product performance.

The major change filed under this application as follows:

MS2220A (I/O board)		
Reason for change	Before	After
01) USB Bus switch control		a) Add connection – USB_MUX_OE
02) Resolve unable to wake using IR issue	a) --	a) ADD BUFFER IC U270 & C1718 FOR IR SIGNAL
03) Improve Audio Performance	a) R1551, R1550, R1548, R1549, R1543, R1544, R1545, R1546 (300ohm)	a) R1551, R1550, R1548, R1549, R1543, R1544, R1545, R1546 (1Kohm)
04) Improve low power logic detection	a) Q94 (FDV301)	a) Q94 (PMBT3904)
05) Audio mapping	a) – b) --	a) U71 (I/O ports remap) b) HDMI 1 (Add HDMI_MCLK to GRIFFIN) (Optional)
06) Improve HDMI trace impedance	a) – b) – c) – d) --	Add series resistor at HDMI RX port a) R1886, R1885, R1890, R1892, R1887, R1888, R1889, R1891, b) R1625, R1624, R1629, R1623, R1626, R1627, R1628, R1632, c) R1894, R1896, R1897, R1899, R1895, R1896, R1897, R1899, d) R1902, R1901, R1906, R1908, R1903, R1904, R1905, R1907
07) Improve CEC signal	a) R1882 (10K) b) Diode D67, D80, D81, D82, D83, D85	a) R1882 (27K) b) Remove diode D67, D80, D81, D82, D83, D85
08) Improve Audio performance	a) --	a) LINE-IN: Add Ferrite (L230) at CONN to Ground
09) Recycle GPIO pin, improve THD	a) --	a) SUBW: Change CONTROL SIGNAL to LI_OMP_EN b) Add Mute circuit
10) Improve Audio performance	LINE-IN: C1576, C1577, C1578, C1579 a) With polarity b) 100uF	LINE-IN: C1576, C1577, C1578, C1579 a) Change E-cap to non-polarity type b) 10uF
11) CHANGE reduce OPAMP GAIN		Change value:

Improve THD & output matching	a) R1395 (1K), b) R1165 (1K), c) R1397 (1K), d) R1396 (1K)	a) R1395 (11K), b) R1165 (15K), c) R1397 (15K), d) R1396 (11K)
12) EMI - patched at 4P board during the test		a) INT MIC: Add 27pF between AG and GROUND
13) Correction	a) J26	a) J26: Swap Mic L R signal
14) Help discharge USB HUB_3V3 faster	a) --	a) Add Resistor (R1916) LOAD TO USB HUB_3V3 POWER
15) Improve IC mcore IC 1V2 supply voltage	a) R1383 (3K)	Change value a) R1383 (2K7)
16) To meet DDC pull high spec	a) R1861, R1862, R1597, R1598 (47K)	Change value a) R1861, R1862, R1597, R1598 (2K)
17) Reduce mic noise	a) R1883 (0ohms)	a) Remove R1883 (0ohms)
18) Add location	a) --	a) Add J79 location (not mounted)
19) Change control signal	a) U265	a) U265 (Change control signal)
20) Set EEPROM to 8-bit mode for LAN7500	a) U217	a) U217 (Pull pin6 to low)
21) Remove STS Audio Noise	a) --	a) Add decoupling caps (C1723 100nF 10V) in between STS_VDD and Ground)
22) Connection correction	a) --	a) U252 (Remove R657, and connect pin 52 to pin 10)
23) Reduce pop sound	a) C1323 & C1324 (1800pF 50V)	a) C1323 & C1324 (Change to resistor 10K)
24) Connection correction	a) U269	a) U269 (Add 10K resistor in between pin12 and ground)

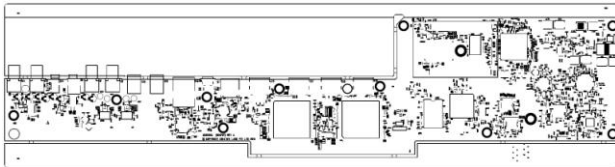
MS2220B (Power supply board)		
Reason for change	Before	After
01) Improve power supply performance	a) -- b) --	a) Add C656 (100uF 400V) b) Add Diode D622 (FM4007)
02) Resolve hissing noise	a) C623 (47pF)	a) Remove C623 (47pF)
03) Improve power supply performance	a) D616 (4148) b) R672 (1K) c) R669 (10K) d) R675 (1R) e) R629 (3K3) f) CM601 (2.8MH) g) C646 (100nF)	Change value a) D616 (4007) b) R672 (47K) c) R669 (100K) d) R675 (0R1) e) R629 (4K7) f) CM601 (12.5MH) g) C646 (10nF)
04) Improve power supply performance	a) C628 (22pF)	a) Remove C628 (22pF)
05) To improve EMC performance	a) --	a) Add R683 (10R)
06) To regulate voltage at U609	a) --	a) Add R682 (100R)
07) To protect mosfet Q606	a) R656 (18K)	a) R656 (1K)

MS2220C (Amplifier board)		
Reason for change	Before	After
01) Control PCM1690_VCC5 power sequence together with PCM1690_VDD33 via DAC_ENB	a) Q70, R825	a) Remove Q70 (TRA0200030110) & R825 (REA01J4702J00) and link Q69's gate to DAC_ENB
02) Unmute audio DAC permanently	a) -- b) --	a) Remove both PCM1690A_AMUTEI control from U93 & U94, b) Add R5063 (REA01J1002J00) pull up to both pin18 of U93 & U94
03) To control the REST of the USB host controller	a) --	a) Add PCM1690_AMUTEI to control pin38 of U2010
04) Improve the audio performance of AUX- in	C2162, C2163, C2164, C2165 a) With polarity type b) 100uF	Change: C2162, C2163, C2164, C2165 to a) Non-polarity type b) 10uF
05) Connection correction	a) --	a) Link AUX_REF_AG with GROUND via L2054 (NDA073600L022)
06) Improve the power up sequence of TMDS_1V2	a) R5052 (3K)	a) R5052 (5K6)
07) Improve the power up sequence of TMDS_3V3	a) --	a) Change connection for R5053, connect between pin 5 of U2041 and Ground
08) Connection correction	a) --	a) Remove link pin 5 of U2041 and gate of Q76
09) Connection correction	a) --	a) Connect pin5 of U2041 to DAC_5V_ENB and connect gate of Q76 to TMDS_1V2
10) Change the HDMI re-timer configuration	a) R5041, R5042	a) Unmount REA01J1002J00 from R5041 & R5042
11) Remove I2C link	a) --	a) Mount REA01J1002J00 on R5059 & R5062
12) Add location	a) --	a) Add series resistor R5064 & R5065 location (Not mounted)
13) To improve MIC audio performance	a) R2039, R2276	a) Unmount REA01003J00 from R2039 & R2276
14) Add Front Mic HW detection for Mic amp	a) --	a) Disconnect Mic BIAS from pin 10 of U2036
15) Power decoupling for MIC	a) C2024 (1uF 10V)	a) C2024 (22uF 10V)
16) Add MIC Bias circuit	a) --	a) Add new MICbias from M33_VCOD33 with R5068 (REA01J1001F00) & R5069 (REA01J2001F00) as potential divider
17) Improve MIC signal performance	a) C2256,C2257,C2254,C2267,C2252 (100nF)	Change value a) C2256,C2257,C2254,C2267,C2252 (1uF)
18) HDMI retime hot plug detect fix	a) R2038 (1K5)	a) Remove R2038 (1K5)

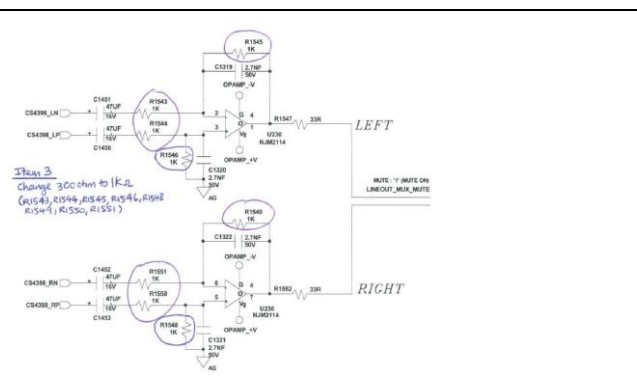
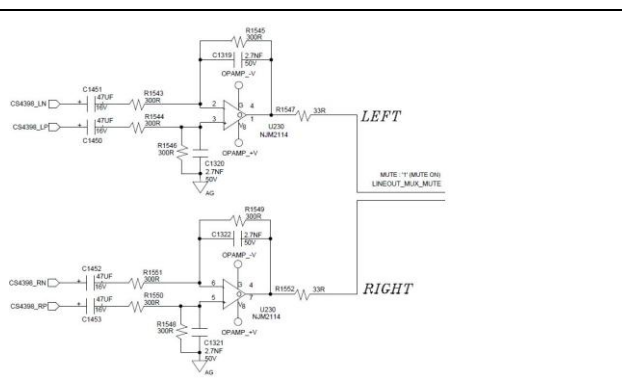
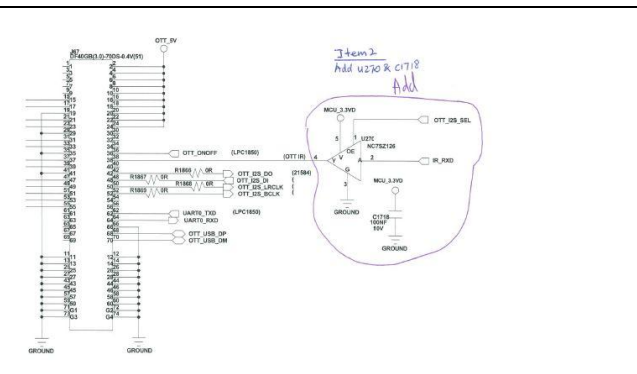
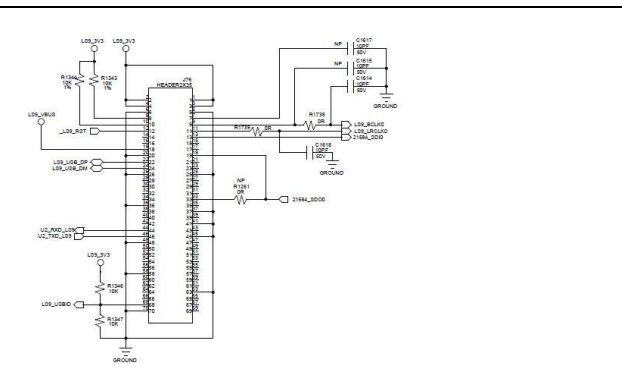
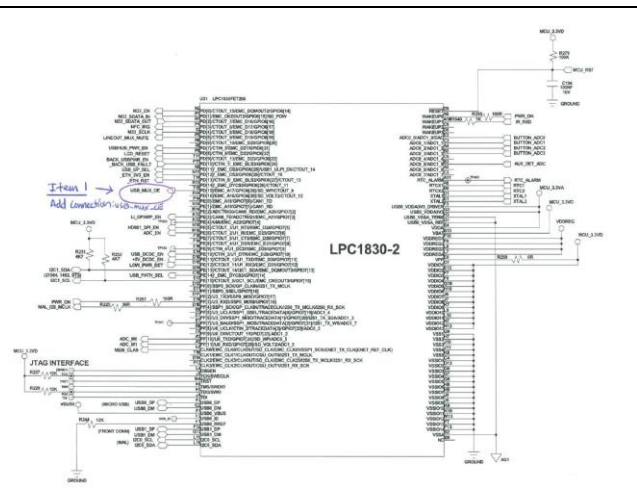
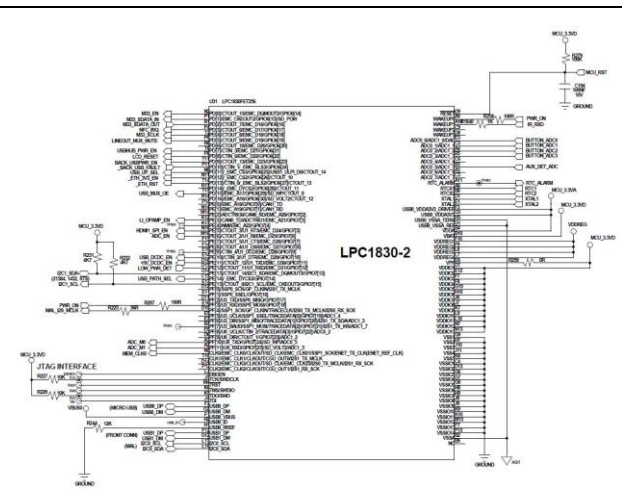
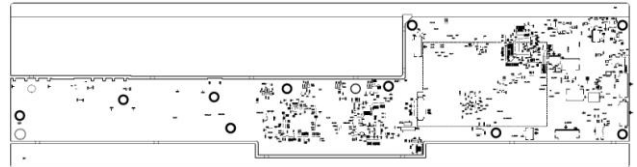
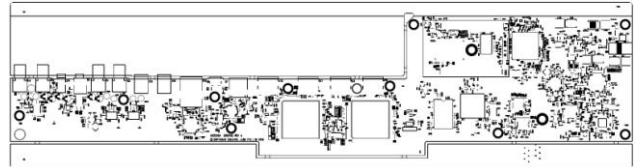
Bluetooth, WiFi, Wireless Audio Module (No Changes)		
Description	Before	After
Bluetooth Module (U252 on PCB board MS2220A) 	Sunitec BM880	Sunitec BM880
WiFi Module Libre (Plug on PCB board MS2220A) 	LS9-AC11DBT	LS9-AC11DBT
OTT board (WiFi Bluetooth Module) (Plug on J67 connector on PCB board MS2220A) 	OTT board: hi3798C V200 WiFi BT Module: CDW-B18821A-00	OTT board: hi3798C V200 WiFi BT Module: CDW-B18821A-00
Wireless Audio Module (External board) 	SMSC DWAM83 TB	SMSC DWAM83 TB

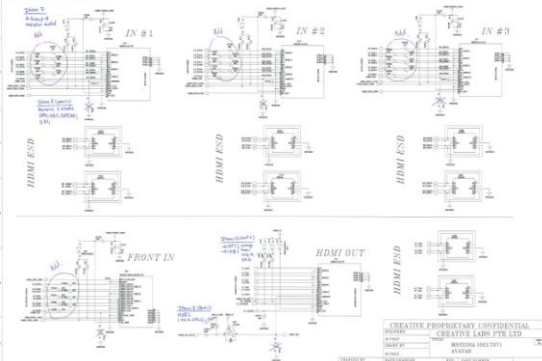
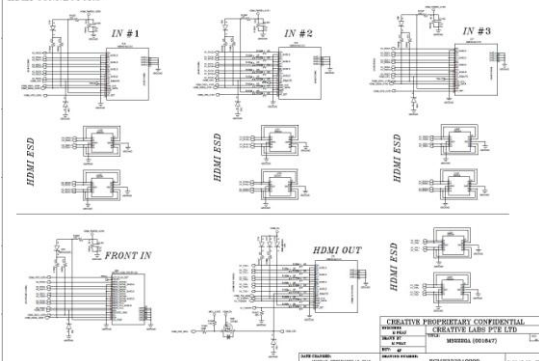
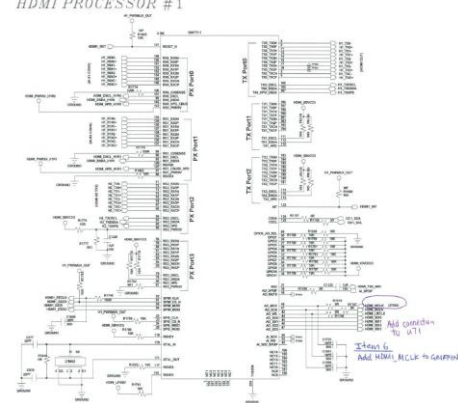
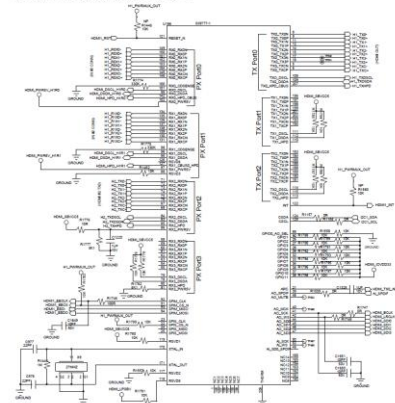
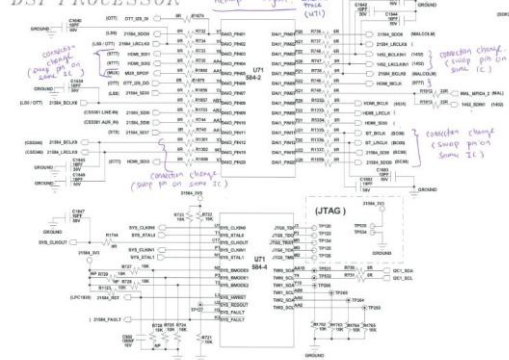
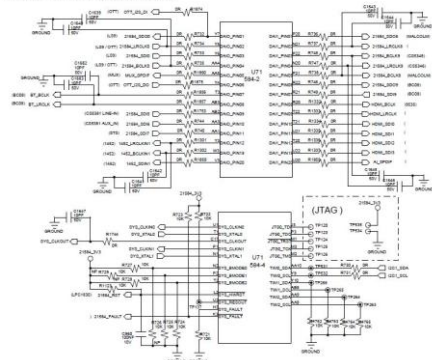
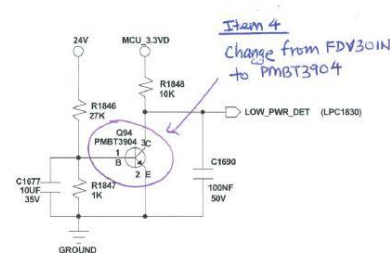
MS2220A (I/O board)

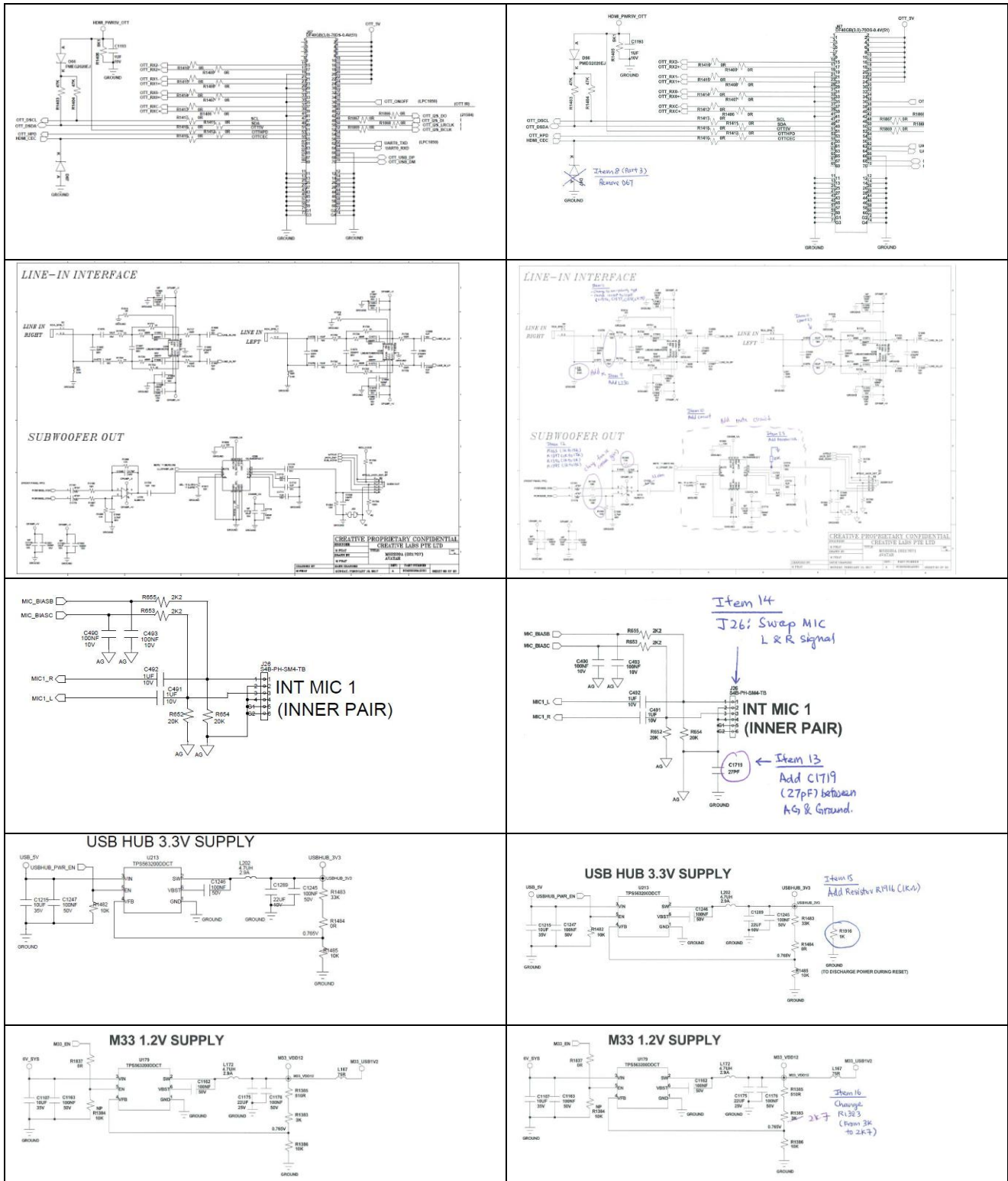
Before



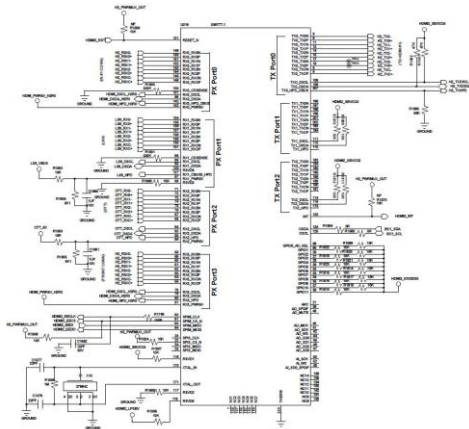
After



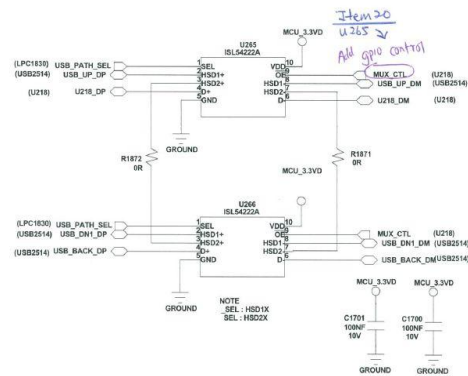
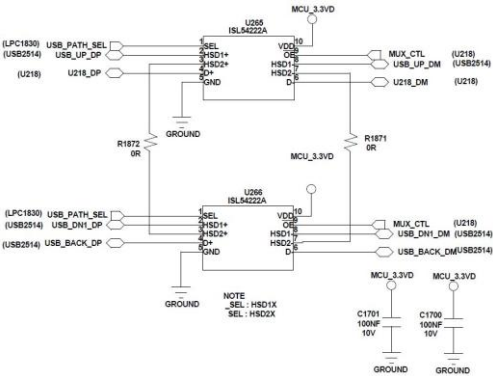
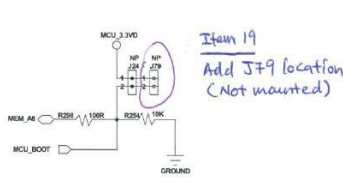
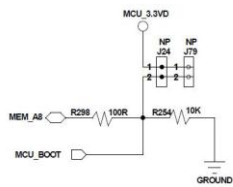
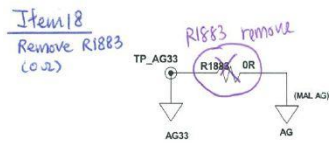
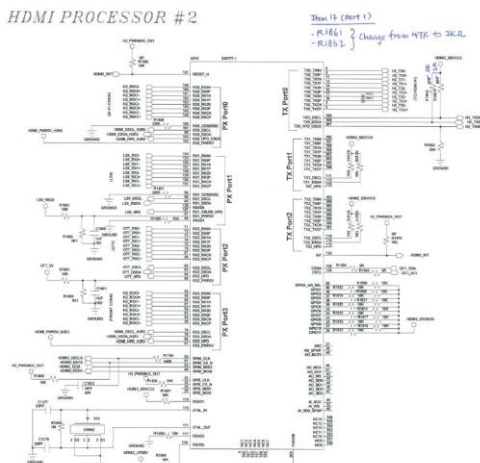




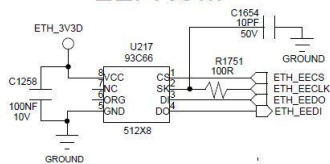
HDMI PROCESSOR #2



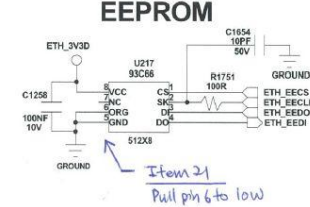
HDMI PROCESSOR #2



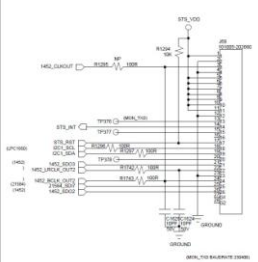
EEPROM



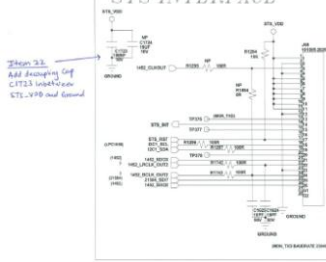
EEPROM

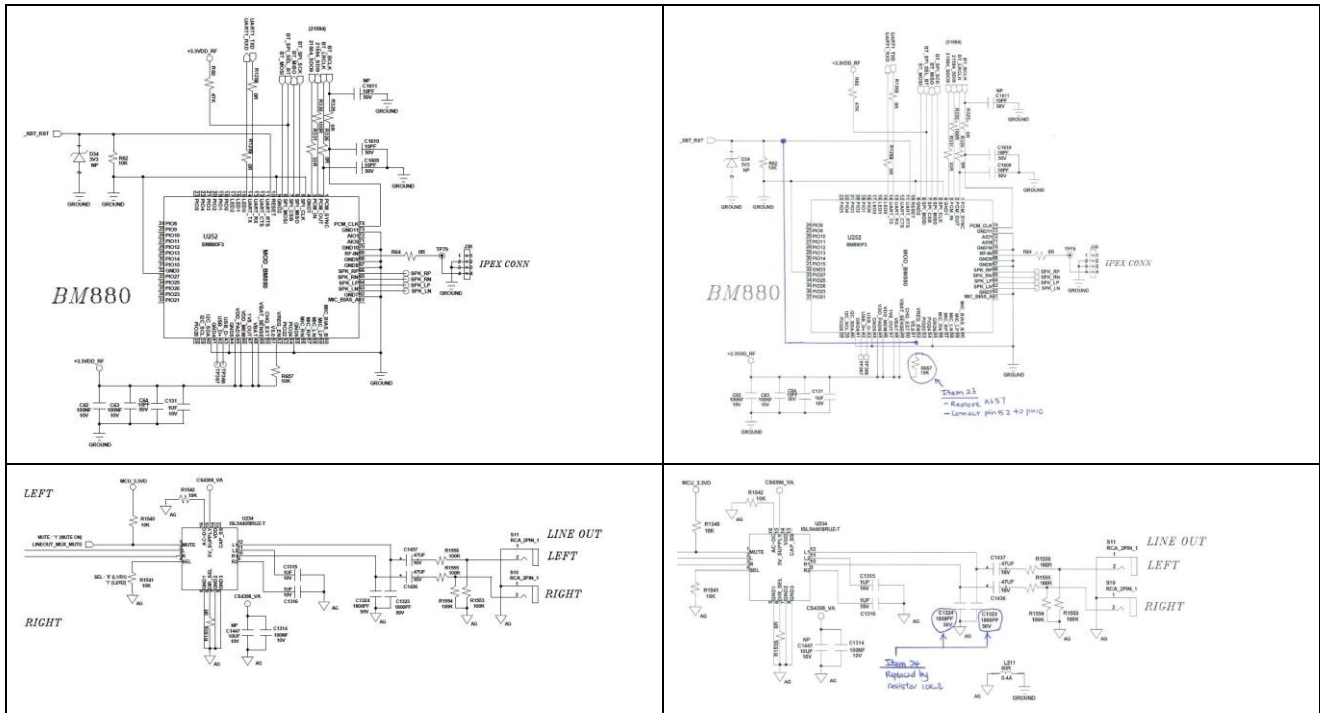


STS INTERFACE



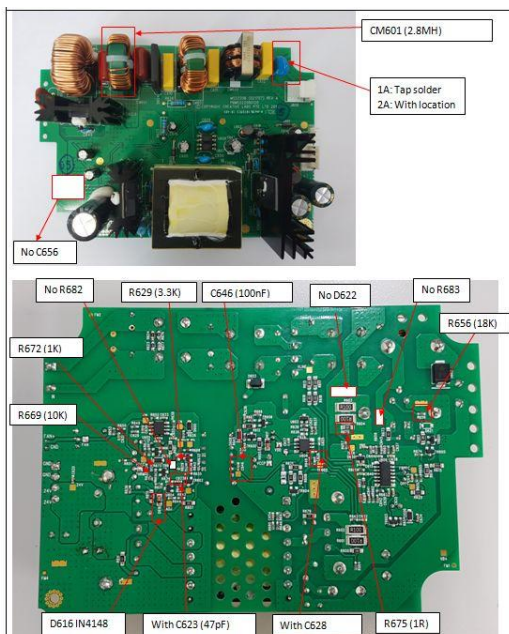
STS INTERFACE



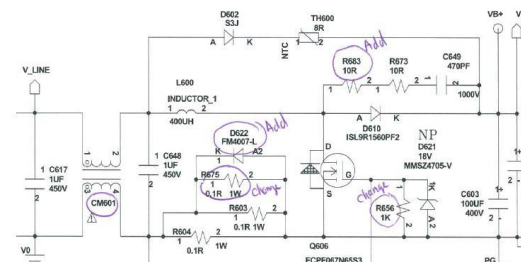
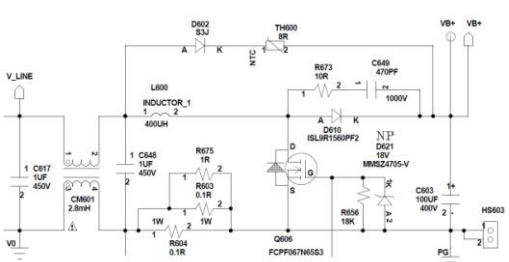
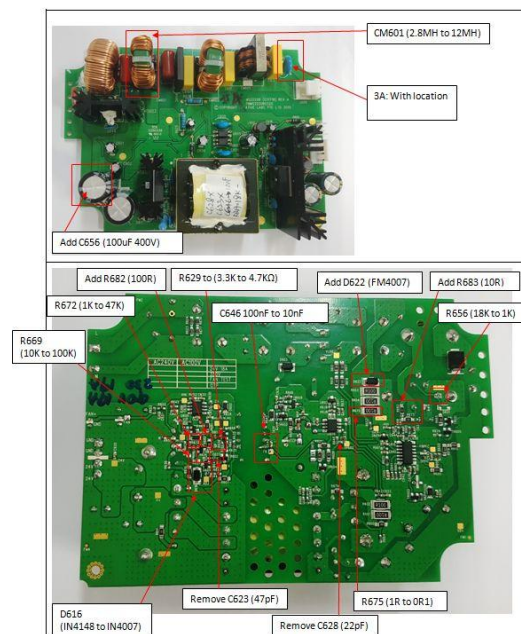


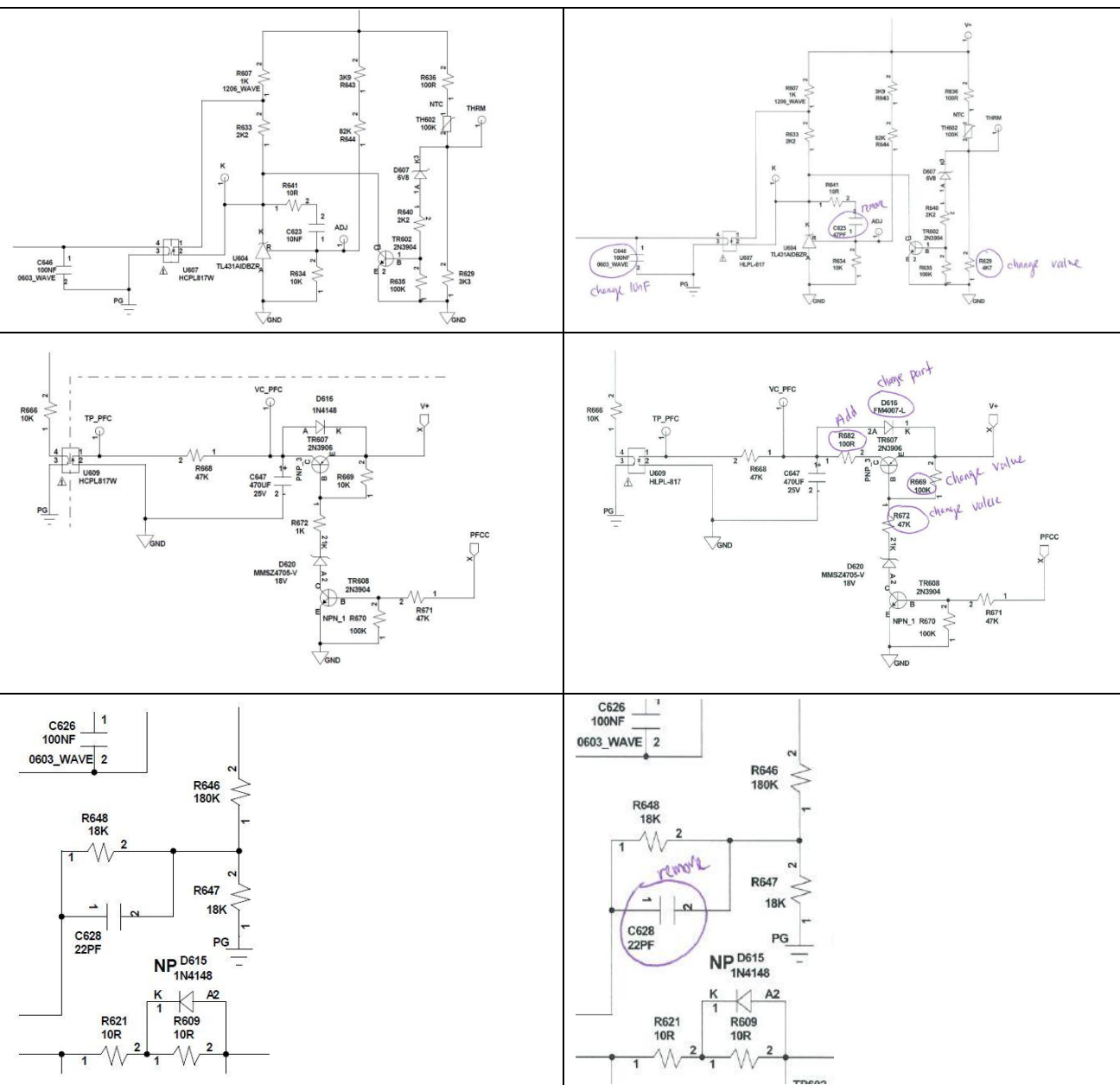
MS2220B (Power Supply board)

Before



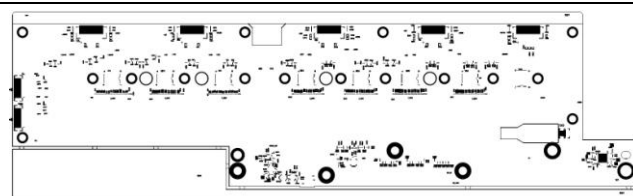
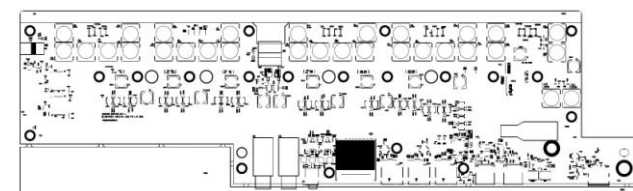
After



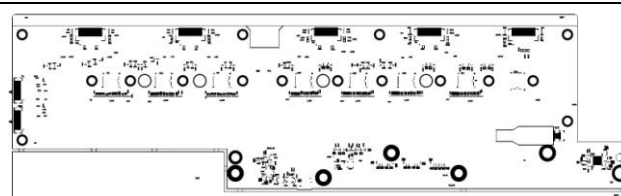
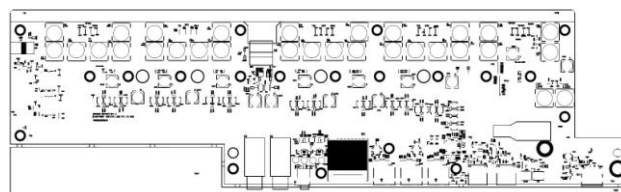


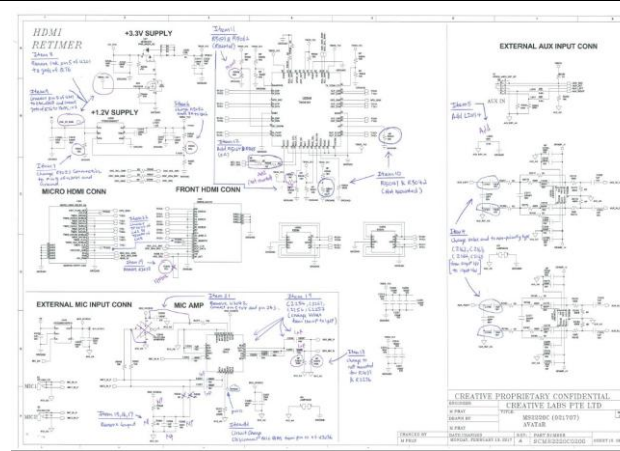
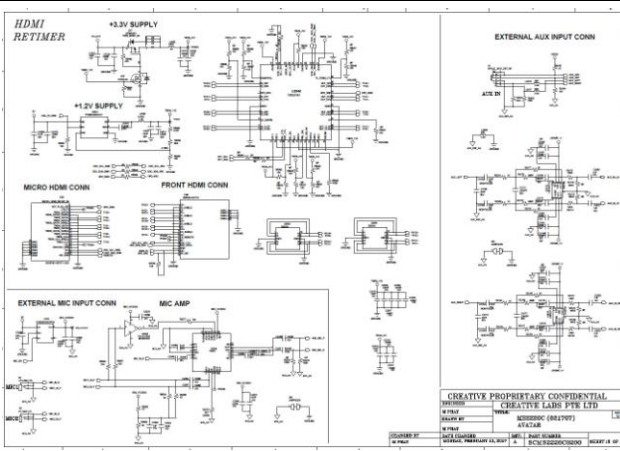
MS2220C (Amplifier board)

Before



After



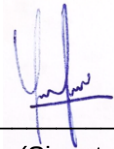


Issue date of original FCC ID is 03 May 2017

Thank you.

Yours Sincerely,

By:



(Signature¹)

LIAN YAM FEI

(Print name)

Title: Assoc Director of Product Development

On behalf of: Creative Labs Inc

(Company Name)

Telephone: +65 6895 4474

¹ - Must be signed by applicant contact given for applicant on the FCC site, or by the authorized agent if an appropriate authorized agent letter has been provided. Letters should be placed on appropriate letterhead.